

April 2009

FODM3011, FODM3012, FODM3022, FODM3023, FODM3052, FODM3053

4-Pin Full Pitch Mini-Flat Package Random-Phase Triac Driver Output Optocouplers

Features

- Compact 4-pin surface mount package (2.4 mm maximum standoff height)
- Peak blocking voltage 250V (FODM301X) 400V (FODM302X) 600V (FODM305X)
- Available in tape and reel quantities of 2500.
- Add "NF098" for new construction version with 260°C max. reflow temperature rating
- UL, C-UL and VDE certifications pending

Applications

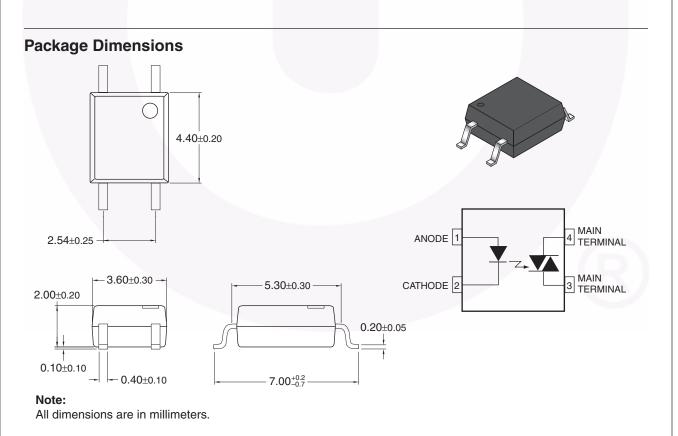
- Industrial controls
- Traffic lights
- Vending machines

Applications (Continued)

- Solid state relay
- Lamp ballasts
- Solenoid/valve controls
- Static AC power switch
- Incandescent lamp dimmers
- Motor control

Description

The FODM301X, FODM302X, and FODM305X series consists of a GaAs infrared emitting diode driving a silicon bilateral switch housed in a compact 4-pin mini-flat package. The lead pitch is 2.54mm. They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115V/240V operations.



Absolute Maximum Ratings ($T_A = 25^{\circ}$ C unless otherwise specified) Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Paramete	Value	Units	
TOTAL PACKAG	GE			1
T _{STG}	Storage Temperature		-55 to +150	°C
T _{OPR}	Operating Temperature		-40 to +100	°C
EMITTER				
I _{F (avg)}	Continuous Forward Current		60	mA
I _{F (pk)}	Peak Forward Current (1µs pulse, 300p	1	Α	
V _R	Reverse Input Voltage		3	V
P _D	Power Dissipation (No derating required	over operating temp. range)	100	mW
DETECTOR				
I _{T(RMS)}	On-State RMS Current		70	mA (RMS)
V _{DRM}	Off-State Output Terminal Voltage FODM3011/FODM3012		250	V
		FODM3022/FODM3023	400	
		FODM3052/FODM3053	600	
P _D	Power Dissipation (No derating required over operating temp. range)		300	mW

Electrical Characteristics (T_A = 25°C)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit
EMITTER	MITTER						
V _F	Input Forward Voltage	I _F = 10mA	All		1.20	1.5	V
I _R	Reverse Leakage Current	$V_R = 3V, T_A = 25^{\circ}C$	All		0.01	100	μΑ
DETECTO	DETECTOR						
I _{DRM}	Peak Blocking Current Either Direction	Rated V_{DRM} , $I_F = 0^{(1)}$	All		2	100	nA
dV/dt	Critical Rate of Rise of Off-State Voltage	I _F = 0 (Figure 8) ⁽²⁾	FODM3011, FODM3012, FODM3022, FODM3023	1,000	10		V/µs
			FODM3053	.,500			

Transfer Characteristics

Symbol	DC Characteristics	Test Conditions		Device	Min.	Тур.*	Max.	Unit
I _{FT}	LED Trigger Current	Main Terminal Voltage = 3V ⁽³⁾	F	ODM3011, ODM3022, ODM3052			10	mA
			F	ODM3012, ODM3023, ODM3053			5	
I _H	Holding Current, Either Direction			All		300		μΑ
V _{TM}	Peak On-State Voltage Either Direction	I _{TM} = 100mA peak		All		1.7	3	V

Isolation Characteristics

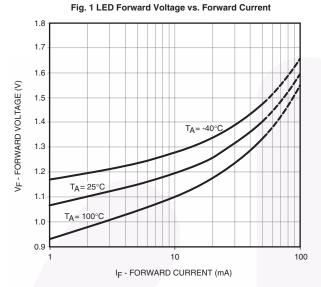
Symbol	Characteristic	Test Conditions	Device	Min.	Тур.*	Max.	Unit
V _{ISO}	Steady State Isolation	1 Minute,	All	3750			VRMS
	Voltage	R.H. = 40% to 60%					

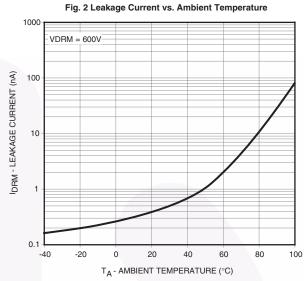
^{*}All typicals at T_A = 25°C

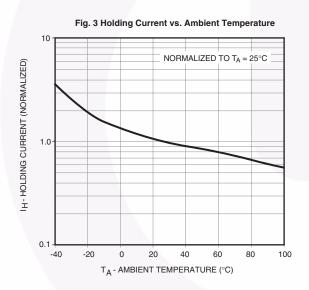
Notes:

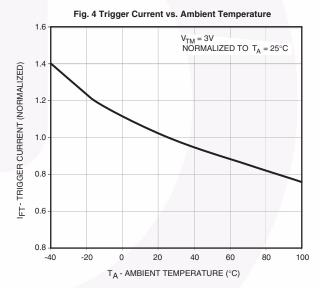
- 1. Test voltage must be applied within dv/dt rating.
- 2. This is static dv/dt. See Figure 1 for test circuit Commutating dv/dt is function of the load-driving thyristor(s) only.
- 3. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT} . Therefore, recommended operating I_F lies between max I_{FT} (10mA for FODM3011, FODM3022, and FODM3052, 5mA for FODM3012, FODM3023, and FODM3053) and absolute max I_F (60mA).

Typical Performance Curves









Typical Performance Curves (Continued)

Fig. 5 LED Current Required to Trigger vs. LED Pulse Width

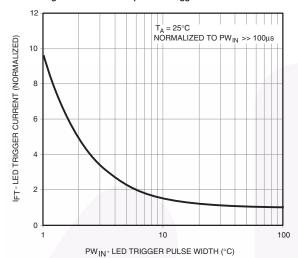


Fig. 6 Off-State Output Terminal Voltage vs. Ambient Temperature

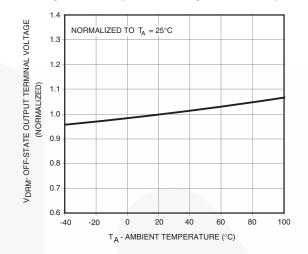
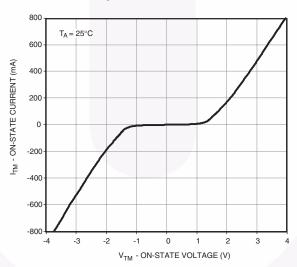
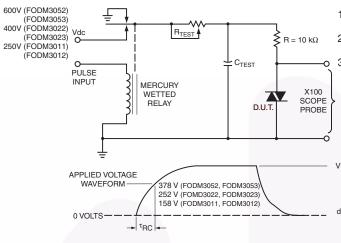


Fig. 7 On-State Characteristics



Typical Application Information



- The mercury wetted relay provides a high speed repeated pulse to the D.U.T.
- 100x scope probes are used, to allow high speeds and voltages.
- The worst-case condition for static dv/dt is established by triggering the D.U.T. with a normal LED input current, then removing the current. The variable R_{TEST} allows the dv/dt to be gradually increased until the D.U.T. continues to trigger in response to the applied voltage pulse, even after the LED current has been removed. The dv/dt is then decreased until the D.U.T. stops triggering. τ_{RC} is measured at this point and recorded.

V_{max} = 600 V (FODM3052, FODM3053) = 400 V (FODM3022, FODM3023) = 250 V (FODM3011, FODM3012)

 $= \frac{0.63 \text{ Vmax}}{^{\text{T}}\text{RC}} = \frac{\frac{378}{^{\text{T}}\text{RC}} \text{ (FODM3053)}}{^{\text{T}}\text{RC} \text{ (FODM3052)}}$ $= \frac{252}{^{\text{T}}\text{RC}} \text{ (FODM3023)}$

158 (FODM3011) TRC (FODM3012)

NOTE: This optoisolator should not be used to drive a load directly. It is intended to be a trigger device only.

Figure 8. Static dv/dt Test Circuit

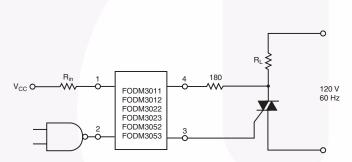


Figure 9. Resistive Load

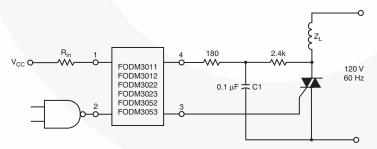
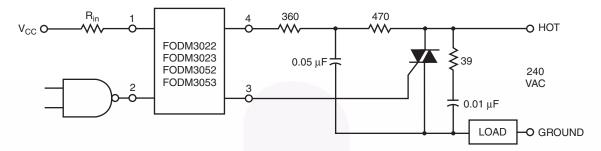


Figure 10. Inductive Load with Sensitive Gate Triac (I $_{GT} \leq$ 15 mA)

Typical Application Information (Continued)



In this circuit the "hot" side of the line is switched and the load connected to the cold or ground side.

The 39Ω resistor and $0.01\mu\text{F}$ capacitor are for snubbing of the triac, and the 470Ω resistor and $0.05\mu\text{F}$ capacitor are for snubbing the coupler. These components may or may not be necessary depending upon the particular and load used.

Figure 11. Typical Application Circuit

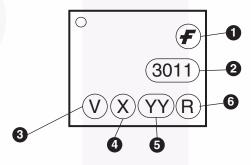
Ordering Information

Option	Description			
V_NF098	VDE Approved			
R2_NF098	Tape and Reel (2500 units)			
R2V_NF098	Tape and Reel (2500 units) and VDE Approved			

Note:

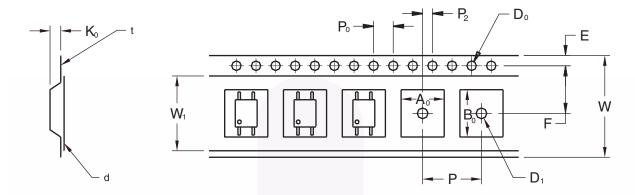
To specify the new construction version with 260° C max reflow peak temperature rating: Add "NF098" to the end of the part number. The non NF098 version is rated for 230° C peak reflow temperature.

Marking Information



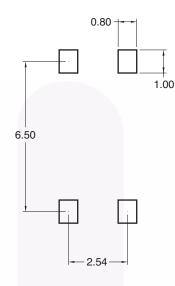
Definiti	ions		
1	Fairchild logo		
2	Device number		
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)		
4	One digit year code		
5	Two digit work week ranging from '01' to '53'		
6	Assembly package code		

Tape Specifications



		2.54 Pitch
Description	Symbol	Dimensions
Tape Width	W	12.00±0.4
Tape Thickness	t	0.35±0.02
Sprocket Hole Pitch	P ₀	4.00±0.20
Sprocket Hole Dia.	D ₀	1.55±0.20
Sprocket Hole Location	E	1.75±0.20
Pocket Location	F	5.50±0.20
	P ₂	2.00±0.20
Pocket Pitch	Р	8.00±0.20
Pocket Dimension	A ₀	4.75±0.20
	B ₀	7.30±0.20
	K ₀	2.30±0.20
Pocket Hole Dia.	D ₁	1.55±0.20
Cover Tape Width	W ₁	9.20
Cover Tape Thickness	d	0.065±0.02
Max. Component Rotation or Tilt		20° max
Devices Per Reel		2500
Reel Diameter		330 mm (13")

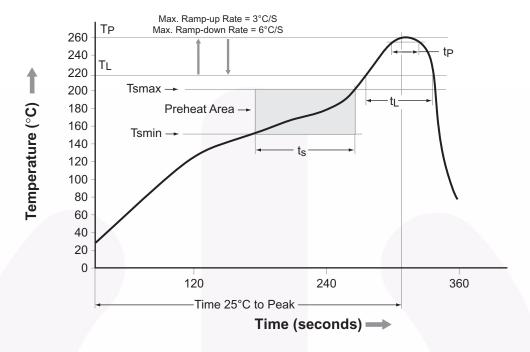
Footprint Drawing for PCB Layout



Note:

All dimensions are in mm.

Reflow Profile



Profile Freature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t _S) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60-150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.





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Definition of Terms					
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